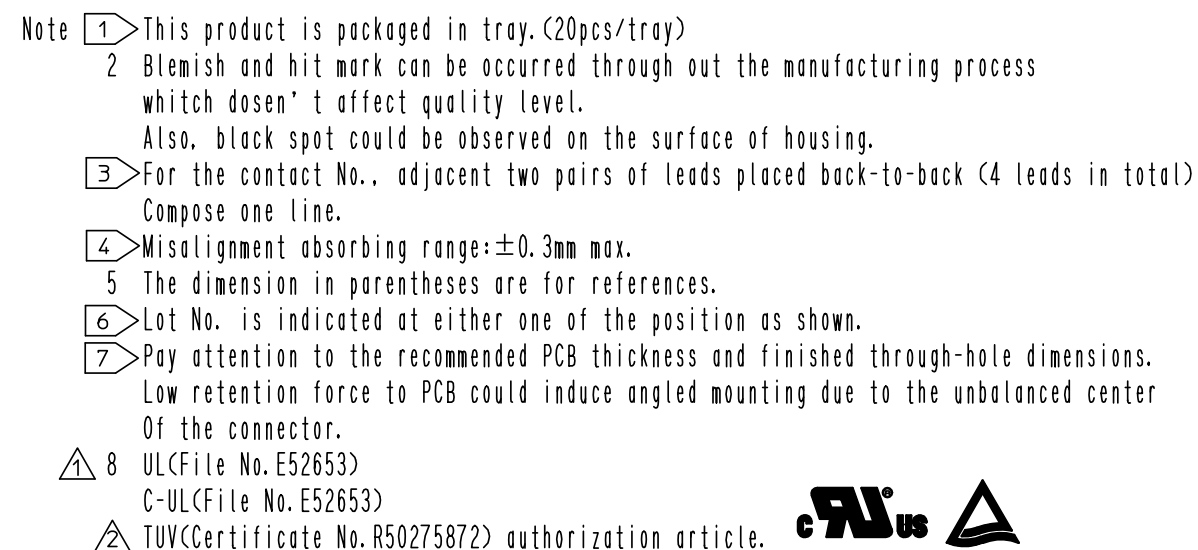
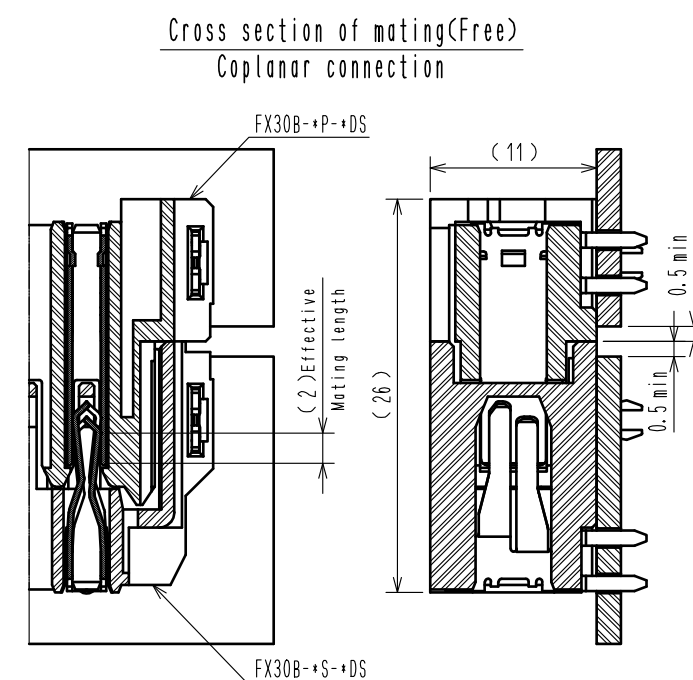
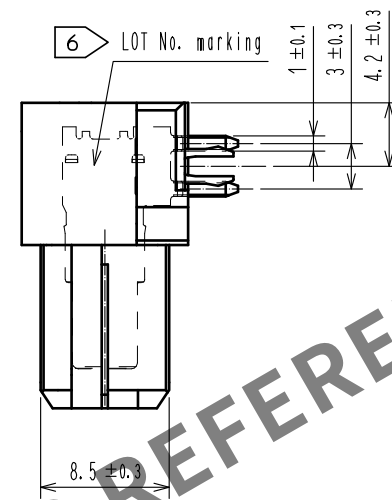
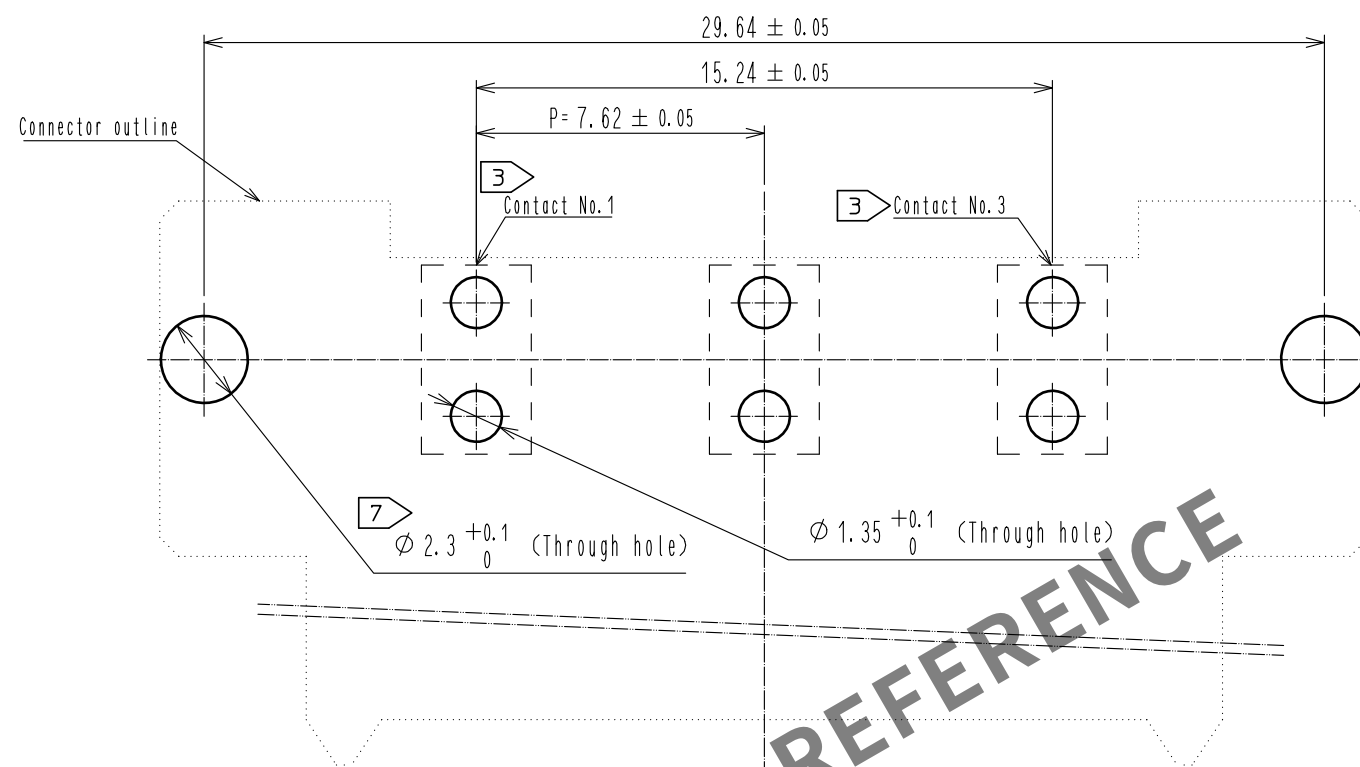


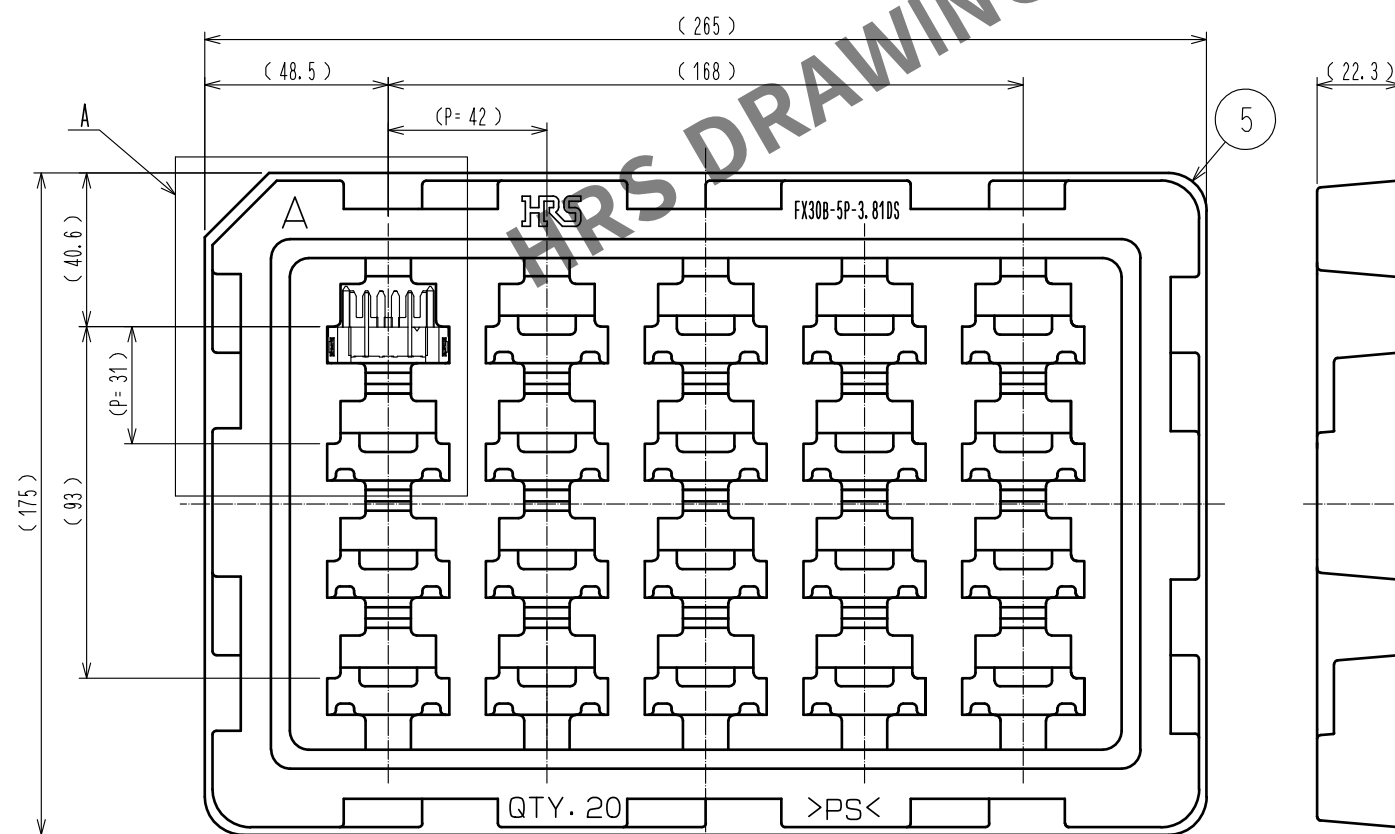


2	Copper alloy	Contact area:Gold-plating 0.1μm	4	Phosphor bronze	Under plating:Nickel 1.0μm				
1	Polyamide	Lead area:Tin-plating 1.0μm	3	Copper alloy	Contact area:Gold-plating 0.1μm				
		Under plating:Nickel 1.0μm			Lead area:Tin-plating 1.0μm				
		Black UL94V-0			Under plating:Nickel 1.0μm				
NO.	MATERIAL	FINISH . REMARKS		NO.	MATERIAL	FINISH . REMARKS			
UNITS mm		SCALE 2 : 1		COUNT 1	DESCRIPTION OF REVISIONS DIS-F-00006019		DESIGNED AK. IWAHORI	CHECKED HT. YAMAGUCHI	DATE 20200401
 HIROSE ELECTRIC CO., LTD.	APPROVED	HS. OKAWA	20140912		DRAWING NO. EDC3-359164-00				
	CHECKED	KN. SHIBUYA	20140912		PART NO. FX30B-3P-7. 62DS				
	DESIGNED	DK. AIMOTO	20140912		CODE NO. CL570-3405-0-00				
	DRAWN	DK. AIMOTO	20140912		 				

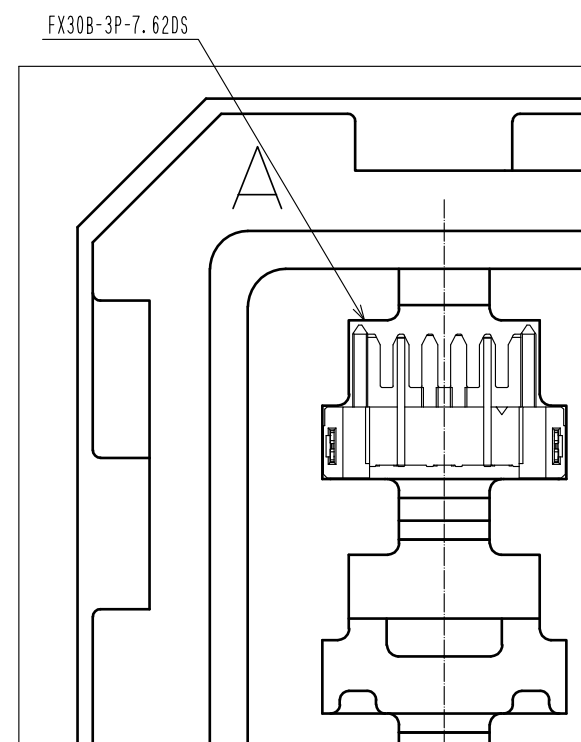
Recommended hole pattern dimension of PCB(5:1)
(Connector mounting side, PCB thickness:t=1.6mm) $\triangleleft 7$



1 Drawing for packaging(1:2)



A(1:1)



HRS

DRAWING NO.	EDC3-359164-00
PART NO.	FX30B-3P-7.62DS
CODE NO.	CL570-3405-0-00

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